### **Product Preview**

# 4 Megabit 128K x 32 Bit Fast SRAM Multi-Chip Module

The 46226 is a 4,096,000 bit static random access memory organized as 131,072 words of 8, 16, 24 or 32 bits. The module is constructed using four 6226 static RAM die mounted in a multilayer co-fired hermetic ceramic sealed package.

- High Density 4.0 Megabit SRAM (128K x 32)
- High Speed CMOS SRAMS
- Fast Access Time Military 25 ns (Max)
- Available in 68 pin hermetic package (1.7 inch x 0.900 inch)
- Single 5.0 V (±10%) Power Supply
- Two Module Controls

E,  $\overline{\mathsf{E}}$  for Automatic Power Down

G for Fast Access to Data

Pin Names and Function				
A <sub>0</sub> — A <sub>16</sub>	Address Inputs			
W	Write Enable			
$E_0 - E_3$ , $\overline{E}_0 - \overline{E}_3$	Chip Enable			
G	Output Enable			
I/O <sub>0</sub> — I/O <sub>31</sub>	Data I/O			
Vcc	+ 5.0 volt Power Supply			
V <sub>SS</sub>	Ground			

	Truth Table						
E	Ē	G	W	Mode	V <sub>CC</sub> Currents	I/O Pin	Cycle
L	Х	Х	Х	Not Selected	ISB1, ISB2	HI-Z	_
Х	H	Х	Х	Not Selected	ISB1, ISB2	HI-Z	_
Н	L	Н	H	Read	ICCA	HI-Z	
Н	L	L	Н	Read	ICCA	DOUT	Read Cycle
Н	L	Х	L	Write	ICCA	DIN	Write Cycle

X = Don't Care

CA	ΡΔ	CI	ΤΔ	NC	E:

(f = 1.0 MHz, dV = 3.0 V,  $T_A$  = 25°C, Periodically Sampled Rather Than 100% Tested)

Characteristic		Symbol	Тур	Max	Unit
Input Capacitance	All Inputs Except $\overline{E}$ , E and I/O $\overline{E}$ , E	C <sub>in</sub> C <sub>in</sub>	16 20	24 28	pF pF
I/O Capacitance	DQ (I/O)	C <sub>I/O</sub>	20	28	pF

## Military 46226



SRAM MULTI-CHIP MODULE

**AVAILABLE AS** 

1) JAN: N/A 2) SMD: N/A 3) 883: Planned

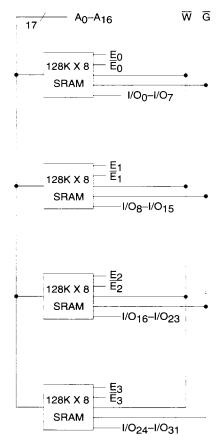
X = CASE OUTLINE AS FOLLOWS:

PACKAGE:

DIL: 46226-XX/BXAJC (Form Leads) DIL: 46226-XX/BYAJC XX = Speed in ns (25, 30, 35, 45)

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#### **BLOCK DIAGRAM**



This document contains information on a product under development. Motorola reserves the right to change or discontinue this product without notice.



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#### PACKAGE OFFERING

#### 68 PIN DUAL-IN-LINE SIDEBRAZE



## 68 PIN DUAL-IN-LINE SIDEBRAZE (FORMED LEAD OPTION)



FOR MORE INFORMATION CONTACT **DENNIS MAHAR** (602) 897-3541 CUSTOM MODULE MARKETING

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